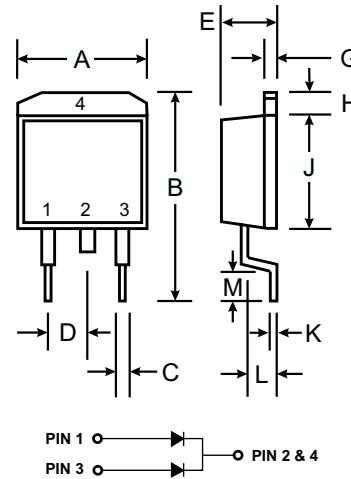


Features

- Schottky Barrier Chip
- Guard Ring Die Construction for Transient Protection
- Low Power Loss, High Efficiency
- High Surge Capability
- High Current Capability and Low Forward Voltage Drop
- Surge Overload Rating to 250A Peak
- For Use in Low Voltage, High Frequency Inverters, Free Wheeling, and Polarity Protection Applications
- Plastic Material: UL Flammability Classification Rating 94V-0

Mechanical Data

- Case: D²PAK Molded Plastic
- Terminals: Solderable per MIL-STD-202, Method 208
- Polarity: See Diagram
- Marking: Type Number
- Weight: 1.7 grams (approx.)
- Mounting Position: Any



D ² PAK		
Dim	Min	Max
A	9.65	10.69
B	14.60	15.88
C	0.51	1.14
D	2.29	2.79
E	4.37	4.83
G	1.14	1.40
H	1.14	1.40
J	8.25	9.25
K	0.30	0.64
L	2.03	2.92
M	2.29	2.79
All Dimensions in mm		

Maximum Ratings and Electrical Characteristics @ T_A = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

Characteristic	Symbol	SBG 3030CT	SBG 3040CT	SBG 3045CT	SBG 3050CT	SBG 3060CT	Unit
Peak Repetitive Reverse Voltage	V _{RRM}	30	40	45	50	60	V
Working Peak Reverse Voltage	V _{RWM}						
DC Blocking Voltage	V _R						
RMS Reverse Voltage	V _{R(RMS)}	21	28	32	35	42	V
Average Rectified Output Current @ T _C = 100°C	I _O	30					A
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	I _{FSM}	250					A
Forward Voltage, per Element @ I _F = 15A, T _C = 25°C	V _{FM}	0.55			0.70		V
Peak Reverse Current @ T _C = 25°C at Rated DC Blocking Voltage @ T _C = 100°C	I _{RM}				1.0 75		mA
Typical Junction Capacitance (Note 2)	C _j	420					pF
Typical Thermal Resistance Junction to Case (Note 1)	R _{θJC}	1.5					K/W
Operating and Storage Temperature Range	T _j , T _{STG}	-65 to +150					°C

Notes: 1. Thermal resistance: junction to case mounted on heat sink.
2. Measured at 1.0MHz and Applied Reverse Voltage of 4.0V DC.

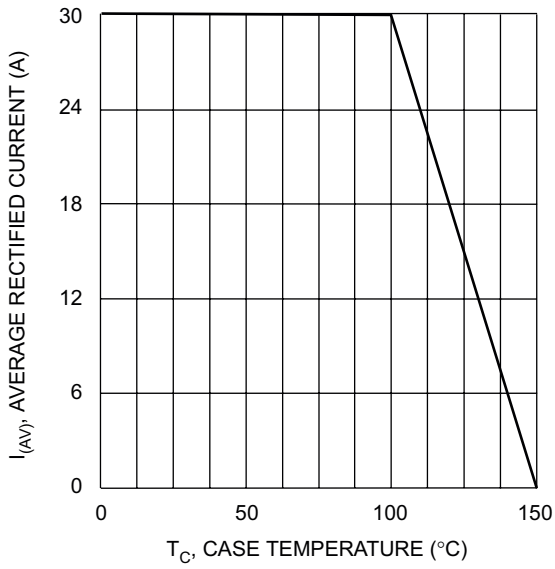


Fig. 1 Forward Derating Curve

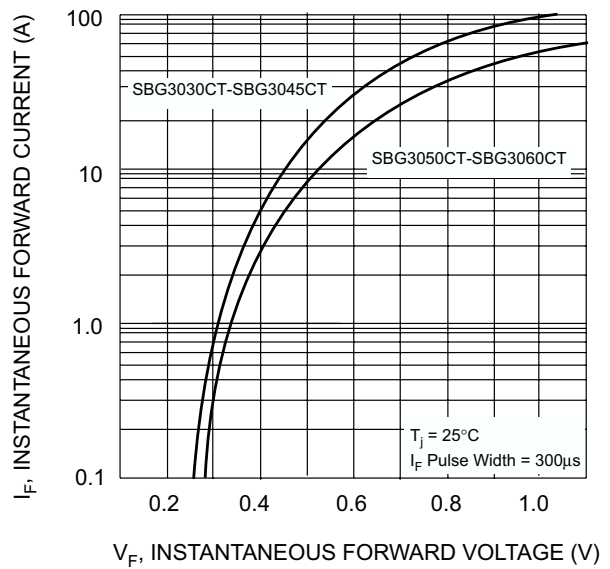


Fig. 2 Typical Forward Characteristics

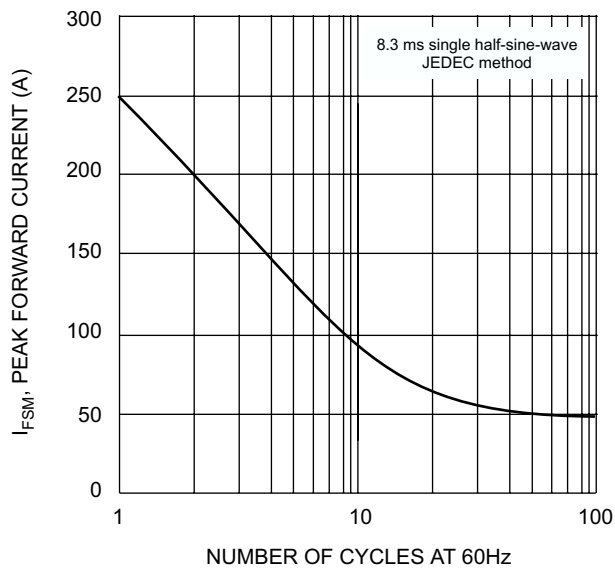


Fig. 3 Maximum Non-Repetitive Surge Current

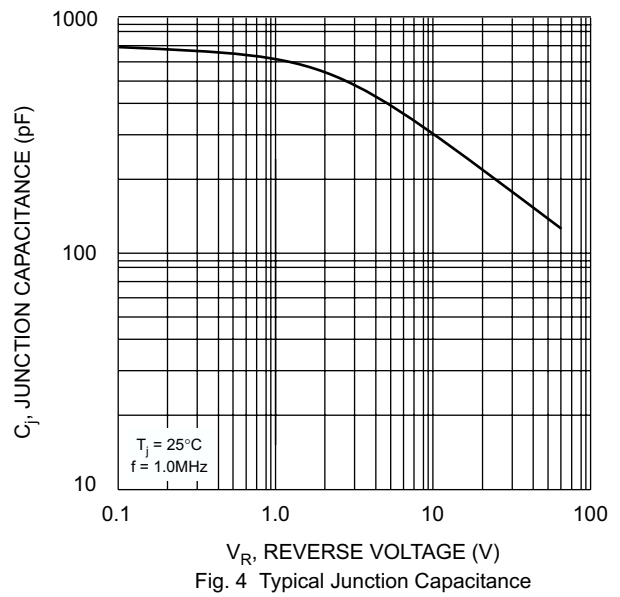


Fig. 4 Typical Junction Capacitance